

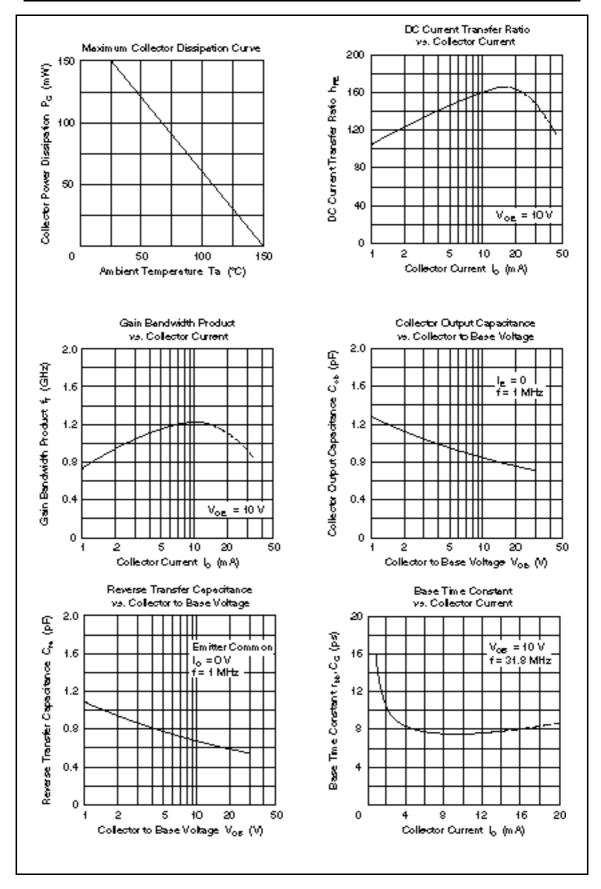
Absolute Maximum Ratings (Ta = 25° C)

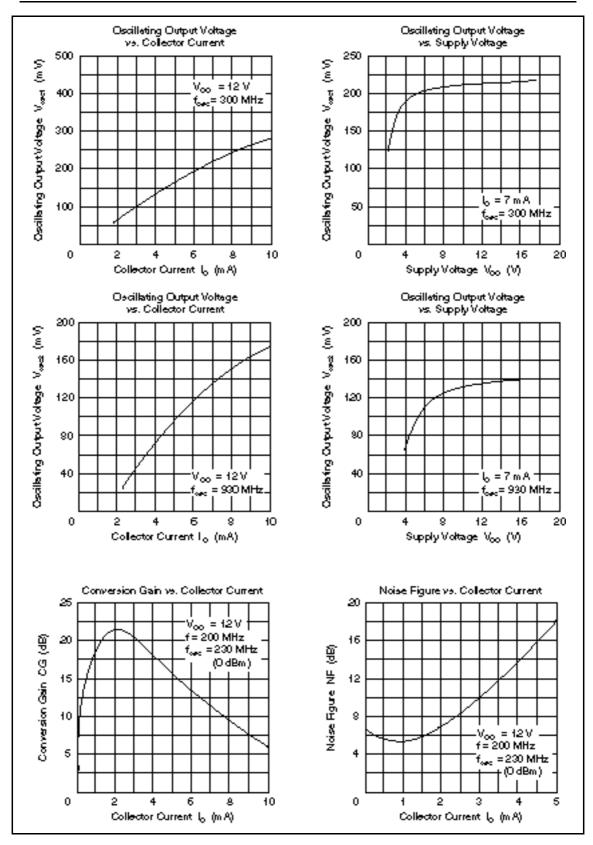
Item	Symbol Ratings		Unit
Collector to base voltage	V _{CBO}	30	V
Collector to emitter voltage	V _{CEO}	20	V
Emitter to base voltage	V _{EBO}	3	V
Collector current	I _c	50	mA
Collector power dissipation	Pc	150	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

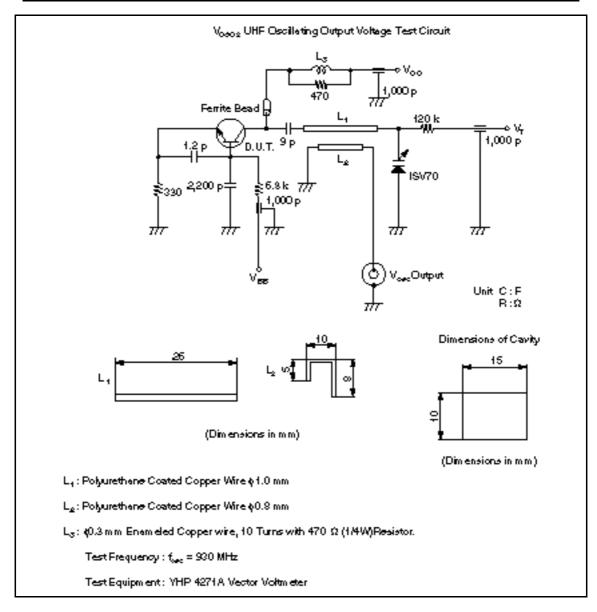
Electrical Characteristics (Ta = 25°C)

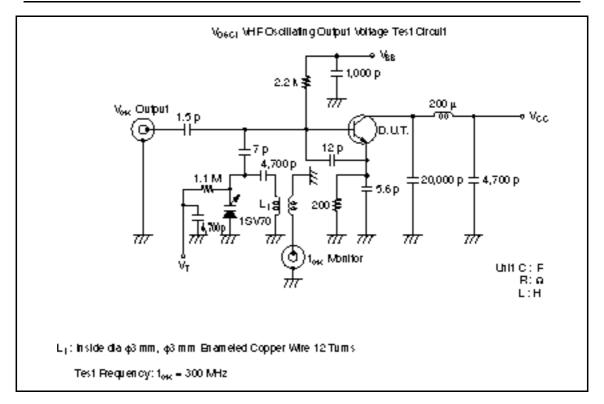
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	—	V	$I_{\rm c} = 10 \ \mu A, \ I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	20	_	—	V	$I_c = 1 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	3	_	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	—	—	0.5	μA	$V_{CB} = 10 \text{ V}, I_{C} = 0$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{c} = 20 \text{ mA}, I_{B} = 4 \text{ mA}$
DC current transfer ratio	h _{FE}	40	_	—		V_{ce} = 10 V, I _c = 10 mA
Collector output capacitance	Cob	—	0.85	1.5	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f _T	600	1200		MHz	$V_{ce} = 10 \text{ V}, I_c = 10 \text{ mA}$
Oscillating output voltage	V _{osc1}	_	210	_	mV	V_{cc} = 12 V, I _c = 7 mA, f _{osc} = 300 MHz
	V _{osc2}	_	130	_	mV	V_{cc} = 12 V, I _c = 7 mA, f _{osc} = 930 MHz
Conversion gain	CG	—	21	_	dB	$V_{cc} = 12 \text{ V}, \text{ I}_{c} = 2 \text{ mA},$ f = 200 MHz, f _{osc} = 230 MHz (0dBm)
Noise figure	NF	—	6.5		dB	$V_{cc} = 12 \text{ V}, \text{ I}_{c} = 2 \text{ mA},$ f = 200 MHz, f _{osc} = 230 MHz (0dBm)

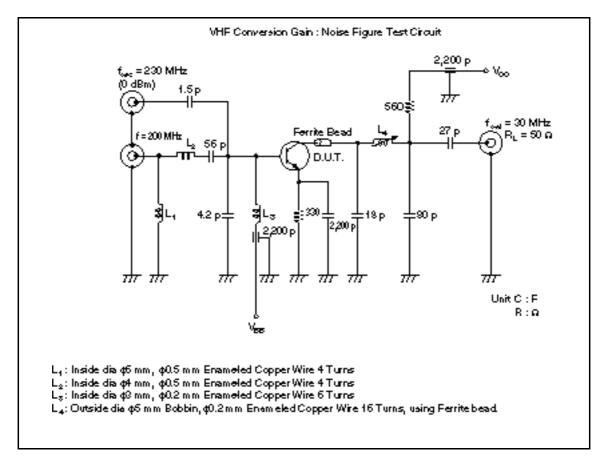
Note: Marking is "JC".











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